Overview

HP Elite Dragonfly G2 Notebook PC

Left

1. Internal Microphones
2. IR Camera LEDs
3. Webcam and IR Camera
4. Privacy Camera Shutter
5. Webcam LED
6. Glass Clickpad
7. WWAN SIM (Nano) [1]
8. Nano Security Lock Slot (Lock sold separately)
9. Power Button
10. SuperSpeed USB Type-A 5Gbps signaling rate (Charging port)

1. All units have a SIM card slot and icon but units that do not support WWAN are shipped with a non-removable SIM slot plug.

Overview

Right

1. HDMI 2.0 port (Cable not included)
2. Audio Combo Jack
3. SuperSpeed USB Type-C® 5Gbps signaling rate
4. SuperSpeed USB Type-C® 5Gbps signaling rate
5. Touch Fingerprint Sensor

Overview

AT A GLANCE

- Precision Machined CNC Mg Unibody with Narrow borders, a chassis that is .63 inches (1.61 cm) thin and with a starting weight of 2.18 lbs. (<1 Kg)
- A 360° convertible notebook with 4 usage modes: Laptop mode, Tablet mode, Tent mode, and Media mode
- Integrated HP Privacy Camera, with HP Sure Shutter to protect from malicious surveillance
- Choice of 11th Generation Intel® Core™ i7, i5 and i3 processors
- Intel® EVO configurations available
- Intel® Core™ i5 and i7 feature integrated Intel® Iris® Xe Graphics
- Touch display choices include 33.78 cm (13.3") diagonal IPS FHD displays or stunning UHD HDR-400 display. Brightness choices up to 1000 Nits. Get added protection in open or public places with the optional HP Sure View Reflect integrated privacy screen
- Ultimate connectivity with dual Thunderbolt4 Type-C® with USB4 support ports, dual USB 3.1 Gen1 charging ports, and HDMI 2.0
- Stay connected where you need to with a choice of 5G or 4G/LTE WWAN, WLAN and optional Thunderbolt™ Docking (Sold separately)
- Never forget your password with your choice of simple authentication methods, including the IR camera for face recognition and Touch Fingerprint Sensor for Windows Hello
- LPDDR4X Memory up to 32 GB supports dual channel performance
- Up to xx hours xx mins of battery life (FHD, 4-cell 56 Wh battery) and Up to xx hours of battery life (UHD, 4-cell 56 Wh battery)
- Preinstalled with Windows 10 versions or FreeDOS
- Passed 19 MIL-STD 810H tests [1]
- Instant on/instant off with Modern Connected Standby
- AI based HP Context Aware to maximize performance when working at a table, comfort when working from your lap, and responsiveness when working on the go
- HP Dynamic Audio, a new AI-based audio experience, tunes output to speech, music, and movies all while suppressing background noise (Planned to be available March 2021.)
- HP Sound Calibration to uniquely tune end user headphone audio (Planned to be available March 2021.)

1. MIL-STD 810H is not intended to demonstrate fitness of U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Accidental damage requires an optional HP Accidental Damage Protection Care Pack.

NOTE: See important legal disclosures for all listed specs in their respective features sections.

Technical Specifications

PRODUCT NAME

HP Elite Dragonfly G2 Notebook PC

OPERATING SYSTEM

Preinstalled

Windows 10 Pro 64 – HP recommends Windows 10 Pro for business [1]
Windows 10 Pro 64 (National Academic License) [2]
Windows 10 Home 64 [1]
Windows 10 Home Single Language 64 [1]
Windows 10 Pro (Windows 10 Enterprise available with a Volume Licensing Agreement) [1]
Windows 10 Enterprise 64 (Web Support)[1]
FreeDOS

1. Not all features are available in all editions or versions of Window. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com/.
2. Some devices for academic use will automatically be updated to Windows 10 Pro Education with the Windows 10 Anniversary Update. Features vary; see https://aka.ms/ProEducation for Windows 10 Pro Education feature information.1 Not all features are available in all editions or versions of Window. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply, and additional requirements may apply over time for updates. See http://www.windows.com/.

Supported Versions
HP tested Windows 10, version 1809 on this platform. For testing information on newer versions of Windows 10, please see https://support.hp.com/document/c05195282

PROCESSORS

Intel® Core™ i7-1185G7 (3.0 GHz base frequency, up to 4.8 GHz frequency with Intel® Turbo Boost Technology, 12 MB L3 cache, 4 cores), supports Intel® vPro® Technology [3,4 5,6]
Intel® Core™ i7-1165G7 (2.8 GHz base frequency, up to 4.7 GHz with Intel® Turbo Boost Technology, 12 MB L3 cache, 4 cores) [3,4 5,6]
Intel® Core™ i5-1145G7 (2.6 GHz base frequency, up to 4.4 GHz frequency with Intel® Turbo Boost Technology, 8 MB L3 cache, 4 cores), supports Intel® vPro® Technology [3,4 5,6]
Intel® Core™ i5-1135G7 (2.4 GHz base frequency, up to 4.2 GHz with Intel® Turbo Boost Technology, 8 MB L3 cache, 4 cores) [3,4 5,6]
Intel® Core™ i3-1115G4 with Intel® UHD Graphics (3.0 GHz base frequency, up to 4.1 GHz with Intel® Turbo Boost Technology, 6 MB L3 cache, 2 cores) [3,4 5,6]

Processor Family
11th Generation Intel® Core™ i7 processor (i7- 1185G7, i7- 1165G7) [6]
11th Generation Intel® Core™ i5 processor (i5-1145G7, i5-1135G7) [6]
11th Generation Intel® Core™ i3 processor (i3-1115G4) [6]

Technical Specifications

3. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.
4. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.
5. Intel® Turbo Boost performance varies depending on hardware, software and overall system configuration. See www.intel.com/technology/turboboost for more information.
6. In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com.

CHIPSET

Chipset is integrated with processor

GRAPHICS

Integrated
Intel® Iris® Xᵉ Graphics[7]
Intel® UHD Graphics

Supports
Support HD Decode, DX12, HDMI 2.0[8]

7. Intel® Iris® Xe Graphics capabilities require system to be configured with Intel® Core™ i5 or i7 processors and dual channel memory. Intel® Iris® Xe Graphics with Intel® Core™ i5 or 7 processors and single channel memory will only function as UHD graphics.
8. HDMI cable sold separately.

DISPLAY

Touch
33.8 cm (13.3") diagonal FHD bent, BrightView WLED UWVA eDP 1.4+PSR2, 400 nits, 72 NTSC, Touch, Low Power (1920x1080)[9,10,11]

33.8 cm (13.3") diagonal UHD bent, HDR-400, BrightView WLED UWVA eDP 1.4+PSR2, 550 nits, 95%sRGB, Touch, (3840x2160)[9,10,11]

33.8 cm (13.3") diagonal FHD bent, BrightView WLED UMA eDP 1.4+PSR, 1000 nits, 72% NTSC, Touch with HP Sure View Reflect integrated privacy screen (1920 x 1080) [9,10,11,12]

9. FHD/HD content required to view FHD/HD images.
10. Resolutions are dependent upon monitor capability, and resolution and color depth settings.
11. Actual brightness will be lower with touchscreen or Sure View.
12. HP Sure View integrated privacy screen is an optional feature that must be configured at purchase and is designed to function in landscape orientation.

Technical Specifications

STORAGE AND DRIVES

Primary M.2 Storage
2 TB PCIe® Gen3x4 NVMe™ M.2 SSD TLC [13]
1 TB PCIe® Gen3x4 NVMe™ M.2 SSD TLC [13]
512 GB PCIe® Gen3x4 NVMe™ M.2 SSD TLC [13]
256 GB PCIe® Gen3x4 NVMe™ M.2 SSD TLC [13]
128 GB PCIe® Gen3x4 NVMe™ M.2 SSD TLC [13]

512 GB PCIe® NVMe™ Value M.2 SSD [13]
256 GB PCIe® NVMe™ Value M.2 SSD [13]

512 GB PCIe® Gen3x4 NVMe™ M.2 SED SSD TLC [13]
256 GB PCIe® Gen3x4 NVMe™ M.2 SED SSD TLC [13]

512 GB Intel® PCIe® NVMe™ QLC M.2 SSD with 32 GB Intel® Optane™ memory H10 [13,14]

13. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.
14. Intel® Optane™ H10 memory system acceleration does not replace or increase the DRAM in your system. Requires 8th Gen or higher Intel® Core™ processor, BIOS version with Intel® Optane™ supported, Windows 10 64-bit, and an Intel® Rapid Storage Technology (Intel® RST) driver.

MEMORY

Maximum Memory
32 GB LPDDR4X-4266 SDRAM [15]

Memory
32 GB LPDDR4X-4266 SDRAM [15]
16 GB LPDDR4X-4266 SDRAM [15]
8 GB LPDDR4X-4266 SDRAM [15]

Memory Slots
LPDDR4X, system runs at 4266
Supports Dual Channel Memory

15. All slots are non-accessible / non-upgradeable.

Technical Specifications

NETWORKING/COMMUNICATIONS

WLAN
Intel® Dual Band Wi-Fi® 6 AX201 802.11a/b/g/n/ac/ax (2x2) WLAN and Bluetooth® 5 Combo, vPro® [16]
Intel® Dual Band Wi-Fi® 6 AX201 802.11a/b/g/n/ac/ax (2x2) WLAN and Bluetooth® 5 Combo, non-vPro® [16]

WWAN
Intel® XMM™ 7360 LTE-Advanced Cat 9 [18]
Qualcomm® Snapdragon™ X55 5G LTE Cat 20 [19]

Miracast
Native Miracast Support [20]

16. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 is backwards compatible with prior 802.11 specs. The specifications for Wi-Fi 6 (802.11ax) are draft and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ax devices.
18. WWAN module is an optional feature, requires factory configuration and requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. LTE not available on all products, in all regions.
19. 5G module is an optional feature that must be configured at purchase. AT&T and T-Mobile networks supported in the U.S. Module designed for 5G networks as carriers deploy Evolved-Universal Terrestrial Radio Access New Radio Dual Connectivity (ENDC) with both 100Mhz of 5G NR and LTE channel bandwidth, using 256QAM 4x4 as defined by 3GPP, requires activation and separately purchased service contract. Check with service provider for coverage and availability in your area. Connection, upload and download speeds will vary due to network, location, environment, network conditions, and other factors. 5G not available on all products, in all regions. Backwards compatible to 4G LTE and 3G HSPA technologies. 5G module planned to be available in select countries, where carrier supported.
20. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming.

AUDIO/MULTIMEDIA

Audio
Audio by Bang & Olufsen
Microphone/Headphone Combo Audio Jack

Camera
720p HD+IR camera with integrated electronic privacy shutter, HP Sure Shutter [21,22]
Note: The on/off button for this shutter is located on the function row of the keyboard.

Sensors
Accelerometer
Magnetometer
Gyroscope
Ambient light sensor
Hall sensor

21. HD content required to view HD images.
22. Sold separately or as an optional feature.

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard
HP Modernized Keyboard, spill resistant, Backlit
Backlit, Spill-resistant, with HP Dura Keys

Pointing Device
Glass Clickpad
Microsoft Precision Touchpad Default Gestures Support

Function Keys
F1 - Display Switching
F2 - Blank or Privacy
F3 - Brightness Down
F4 - Brightness Up
F5 - Audio Mute
F6 - Volume Down
F7 - Volume Up
F8 - Mic Mute
Backlit Toggle
F10 - Insert
F11 - Airplane Mode
F12 - HP Command Center (Programmable Key)
Num Lock
HP Sure Shutter
Print Screen
Delete

SOFTWARE AND SECURITY

Preinstalled Software

BIOS
HP BIOSphere Gen6 [23]
HP Drive Lock & Automatic Drive Lock
BIOS Update via Network
HP Secure Erase [24]
Absolute Persistence Module [25]
HP LAN-Wireless Protection
USB enable/disable (via BIOS)

Software
HP Connection Optimizer [26]
HP Hotkey Support
myHP
HP Support Assistant [27]
HP QuickDrop[17]
HP Noise Cancellation Software
Touchpoint Customizer for Commercial
HP Notifications
HP Privacy Settings
HP Wireless Button Driver
HP Power Manager

Technical Specifications

HP WorkWell
Tile App[28]
HP PC Hardware Diagnostics Windows
Buy Microsoft Office (sold separately)
Microsoft Defender [29]

Manageability Features
HP Driver Packs (download) [30]
HP Manageability Integration Kit Gen4 (download) [31]
HP Client Catalog (download)
HP Client Management Script Library (download)
HP Image Assistant (download)

Security Management
HP Fingerprint Sensor
HP Pro Security Edition (Select models) [32]
HP Sure Click [33]
HP Sure Sense [34]
HP Sure Start Gen6 [35]
HP Sure Admin [36]
HP Sure Recover Gen4 [37]
HP Sure Run Gen4 [38]
HP Client Security Manager Gen7 [39]
Secured-core PC capable [50]
TPM 2.0 Embedded Security Chip (Common Criteria EAL4+ Certified)(FIPS 140-2 Level 2 Certified)

17. HP Quick Drop requires Internet access and Windows 10 PC preinstalled with HP QuickDrop app and either an Android device (phone or tablet) running Android 7 or higher with the Android HP QuickDrop app, and /or an iOS device (phone or tablet) running iOS 12 or higher with the iOS HP QuickDrop app.
23. HP BIOSphere Gen6 is available on select HP Pro and Elite PCs. Features may vary depending on the platform and configurations.
24. HP Secure Erase for the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® Optane™.
25. Absolute firmware module is shipped turned off and can only be activated with the purchase a license subscription and full activation of the software agent. License subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. Certain conditions apply. For full details visit: https://www.absolute.com/about/legal/agreements/absolute/
26. HP Connection Optimizer requires Windows 10.
27. HP Support Assistant requires Windows and Internet access.
28. Some features require optional subscription to Tile Premium. Tile application for Windows 10 available for download from the Windows Store. Mobile phone app available for download from App Store and Google Play. Requires iOS 11 and greater or Android 6.0 and greater see https://support.thetileapp.com/hc/en-us/articles/200424778 for more information. HP Tile will function as long as the PC has battery power.
29. Microsoft Defender Opt in and internet connection required for updates.
30. HP Driver Packs not preinstalled, however available for download at http://www.hp.com/go/clientmanagement.
31. HP Manageability Integration Kit can be downloaded from http://www8.hp.com/us/en/ads/clientmanagement/overview.html.
32. HP Pro Security Edition is available preloaded on select HP PCs and includes HP Sure Click Pro and HP Sure Sense Pro. 3-year license required. The HP Pro Security Edition software is licensed under the license terms of the HP End User License Agreement (EULA) that can be found at: https://h30670.www3.hp.com/ecommerce/common/disclaimer.do#EN_US as modified by the following: "7. Term. Unless otherwise terminated earlier pursuant to the terms contained in this EULA, the license for the HP Pro Security Edition (HP Sure Sense Pro and HP Sure Click Pro) is effective upon activation and will continue for thirty-six (36) months thereafter ("Initial Term"). At the end of the Initial Term you may either (a) purchase a renewal license for the HP Pro Security Edition from HP.com, HP Sales or an HP Channel Partner, or (b) continue using the standard

versions of HP Sure Click and HP Sure Sense at no additional cost with no future software updates or HP Support."
HP Pro Security Edition is optimized for the SMB environment and ships pre-configured - manageability is optional. The HP Pro Security Edition supports a limited tool set that can be used by the HP Manageability Integration Kit which can be downloaded from http://www.hp.com/go/clientmanagement.
33. HP Sure Click requires Windows 10 Pro or Enterprise. See https://bit.ly/2PrLT6A_SureClick for complete details.
34. HP Sure Sense is available on select HP PCs and is not available with Windows10 Home.
35. HP Sure Start Gen6 is available on select HP PCs and requires Windows 10.
36. HP Sure Admin requires Windows 10, HP BIOS, HP Manageability Integration Kit from http://www.hp.com/go/clientmanagement and HP Sure Admin Local Access Authenticator smartphone app from the Android or Apple store.
37. HP Sure Recover Gen4 is available on select HP PCs and requires an open network connection. You must back up important files, data, photos, videos, etc. before using HP Sure Recover to avoid loss of data.
38. HP Sure Run Gen4 is available on select Windows 10 based HP Pro, Elite and Workstation PCs with select Intel® or AMD processors.
39. HP Client Security Manager Gen7 requires Windows and is available on the select HP Elite and Pro PCs.
50. Requires an Intel® vPro® , AMD Ryzen™ Pro processor or Qualcomm® processor with SD850 or higher and requires 8 GB or more system memory. Secured-core PC functionality can be enabled from the factory.

POWER

Power Supply
HP Smart 65 W USB Type-C adapter [40]
HP Smart 65 W Slim USB Type-C adapter[40]

Primary Battery
HP Long Life 2-cell, 38Wh polymer [41,42]
HP Long Life 4-cell, 56Wh polymer [41,42]
HP Fast Charge Technology (50% in 30 minutes) [43]

Battery Life[44]
Up to TBD hours

Battery Weight
0.57 lb /0.259 kg

40. Availability may vary by country.
41. Battery is internal and not replaceable by customer. Serviceable by warranty.
42. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors.
43.Recharges the battery up to 50% within 30 minutes when the system is off or in standby mode. Power adapter with a minimum capacity of 65 watts is required. After charging has reached 50% capacity, charging will return to normal. Charging time may vary +/-10% due to System tolerance.
44. Windows 10 MM18 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See www.bapco.com for additional details.

Technical Specifications

WEIGHTS & DIMENSIONS

Product Weight [45]
Starting at 2.18 lb
Starting at 0.98 kg

Product Dimensions (w x d x h)
11.98 x 7.78 x 0.63 in
30.43 x 19.75 x 1.61 cm

45. Weight will vary by configuration.

PORTS/SLOTS

Ports
2 SuperSpeed USB Type-C® 5Gbps signaling rate
1 SuperSpeed USB Type-A 5Gbps signaling rate (Charging port)
1 Headphone/microphone combo jack
1 HDMI 2.0[46]

46. HDMI cable sold separately.

SERVICE AND SUPPORT

1-year or 3-year limited warranty and 90 day software limited warranty options depending on country.
Batteries have a default one year limited warranty except for HP Long Life batteries which will follow the one or three year warranty of the platform. Refer to http://www.hp.com/support/batterywarranty/ for additional battery information. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc. 47

47. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit http://www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.

CERTIFICATION AND COMPLIANCE

ENERGY STAR® certified[48]
EPEAT® 2019 Gold in the U.S [49]
TCO 8.0 Certified

48. Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. EPEAT® status varies by country. Visit www.epeat.net for more information.
49. Configurations of the HP EliteBook x360 1040 G8 Notebook PC that are ENERGY STAR® qualified are identified as HP EliteBook x360 1040 G8 Notebook PC ENERGY STAR on HP websites and on http://www.energystar.gov.

SYSTEM UNIT

Stand-Alone Power Requirements (AC Power)	**Nominal Operating Voltage**	20V, 3.25A
	Integrated Graphics	Intel UMA
	Max Operating Power	UMA
Shock	**Non-operating**	Comply SVTP
	Operating	Comply SVTP
Random Vibration	**Non-operating**	Comply SVTP
	Operating	Comply SVTP
Altitude (unpressurized)	**Non-operating**	Comply SVTP

Technical Specifications

DISPLAYS

1. Actual brightness will be lower with touchscreen or Sure View.

Note: All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

Panel LCD 13.3 inch FHD (1920x1080) BrightView WLED UWVA 72percent cg 400nits eDP 1.4+PSR2 bent LP NWBZ	**Outline Dimensions (W x H x D)**	299.06 x 176.54 mm (max) (FPC folding included)
	Active Area	293.76 x 165.24 mm (typ.)
	Weight	175 g (max)
	Diagonal Size	13.3 inch
	Thickness	2.0mm / 3.8mm (PCB) (max)
	Interface	eDP 1.4
	Surface Treatment	BrightView
	Touch Enabled	Yes
	Contrast Ratio	1500:1 (typ.)
	Refresh Rate	60 Hz
	Brightness	400nits[1]
	Pixel Resolution	1920 x 1080 (FHD)
	Format	RGB Stripe
	Backlight	LED
	Color Gamut Coverage	72% NTSC (sRGB 100%) (typ.)
	Color Depth	8 bit
	Viewing Angle	UWVA 85/85/85/85

Panel LCD 13.3 inch UHD (3840x2160) BrightView WLED UWVA HDR-400 sRGB 95percent cg 550nits eDP 1.4+PSR2 bent NWBZ	**Outline Dimensions (W x H x D)**	299.06 x 176.54 mm (max) (FPC folding included)
	Active Area	293.76 x 165.24 mm (typ.)
	Weight	200 g (max)
	Diagonal Size	13.3 inch
	Thickness	2.0mm / 3.8mm (PCB) (max)
	Interface	eDP 1.4
	Surface Treatment	BrightView
	Touch Enabled	Yes
	Contrast Ratio	1400:1 (typ.) 1000:1 (HDR off) (min)
	Refresh Rate	60 Hz
	Brightness	550nits[1]
	Pixel Resolution	3840 x 2160 (UHD)
	Format	RGB Stripe
	Backlight	LED
	Color Gamut Coverage	sRGB 95% (min)
	Color Depth	8 bits + 2 FRC
	Viewing Angle	UWVA 85/85/85/85

Technical Specifications

Panel LCD 13.3-in FHD (1920 x 1080) BrightView WLED UWVA 72% cg 1000nits eDP 1.4+PSR PrivacyG4	**Outline Dimensions (W x H)**	299.06 x 176.54 mm (max)
	Active Area	293.76 x 165.24 mm (typ.)
	Weight	220 g (max)
	Diagonal Size	13.3 inch
	Thickness	3.9 mm (max)
	Interface	eDP 1.4 + PSR (4 lane)
	Surface Treatment	BrightView
	Touch Enabled	Yes
	Contrast Ratio	1500:1 (typ.)
	Refresh Rate	60 Hz
	Brightness	1000 nits[1]
	Pixel Resolution	1920 x 1080 (FHD)
	Format of LCD Pixel Arrangement	RGB
	Backlight	LED
	Color Gamut Coverage	72%
	Color Depth	8 bit
	Viewing Angle	UWVA 85/85/85/85

Technical Specifications

STORAGE

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.

SSD 128GB 2280 PCIe-3x2 Three Layer Cell	**Form Factor**	M.2 2280
	Capacity	128 GB
	NAND Type	TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Weight	0.02 lb (10 g)
	Interface	PCIe NVMe Gen3X2
	Maximum Sequential Read	Up To 2047 MB/s
	Maximum Sequential Write	Up To 1200 MB/s
	Logical Blocks	250,069,680
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	TRIM; L1.2

SSD 1TB 2280 PCIe-3x4 NVMe Three Layer Cell single-sided	**Form Factor**	M.2 2280
	Capacity	1 TB
	NAND Type	TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Weight	0.02 lb (10 g)
	Interface	PCIe NVMe Gen3X4
	Maximum Sequential Read	Up To 2800 MB/s
	Maximum Sequential Write	Up To 1600 MB/s
	Logical Blocks	2,000,409,264
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	ATA Security (Option); TRIM; L1.2

Technical Specifications

SSD 256GB 2280 M2 PCIe-3x4 SS NVMe TLC	**Form Factor**	M.2 2280
	Capacity	256 GB
	NAND Type	TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Weight	0.02 lb (10 g)
	Interface	PCIe NVMe Gen3X4
	Maximum Sequential Read	2580 MB/s～ 2600 MB/s
	Maximum Sequential Write	900 MB/s～ 1000 MB/s
	Logical Blocks	500,118,192
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	ATA Security (Option); TRIM; L1.2

SSD 256GB 2280 PCIe-3x4 NVMe Self Encrypted OPAL2 Three Layer Cell	**Form Factor**	M.2 2280
	Capacity	256 GB
	NAND Type	TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Weight	0.02 lb (10 g)
	Interface	PCIe NVMe Gen3X4
	Maximum Sequential Read	Up To 3500 MB/s
	Maximum Sequential Write	Up To 2200 MB/s
	Logical Blocks	500,118,192
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	ATA Security; TCG OPAL 2.0;DIPM; TRIM; L1.2

Technical Specifications

SSD 2TB 2280 PCIe-3x4 NVMe Three Layer Cell single-sided	**Form Factor**	M.2 2280
	Capacity	2 TB
	NAND Type	TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Weight	0.02 lb (10 g)
	Interface	PCIe NVMe Gen3X4
	Maximum Sequential Read	Up To 3000 MB/s
	Maximum Sequential Write	Up To 2100 MB/s
	Logical Blocks	3,907,029,168
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	ATA Security; TCG OPAL 2.0;DIPM; TRIM; DEVSLP

SSD 512GB 2280 M2 PCIe-3x4 SS NVMe TLC	**Form Factor**	M.2 2280
	Capacity	512 GB
	NAND Type	TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Weight	0.02 lb (10 g)
	Interface	PCIe NVMe Gen3X4
	Maximum Sequential Read	2800 MB/s～ 2900 MB/s
	Maximum Sequential Write	1000 MB/s～ 1800 MB/s
	Logical Blocks	1,000,215,215
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	ATA Security (Option); TRIM; L1.2

Technical Specifications

SSD 512GB 2280 PCIe-3x4 NVMe Self Encrypted OPAL2 Three Layer Cell	**Form Factor**	M.2 2280
	Capacity	512 GB
	NAND Type	TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Weight	0.02 lb (10 g)
	Interface	PCIe NVMe Gen3X4
	Maximum Sequential Read	2800 MB/s～ 2900 MB/s
	Maximum Sequential Write	1000 MB/s～ 1800 MB/s
	Logical Blocks	1,000,215,215
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	ATA Security (Option); TCG Opal 2.0; TRIM; L1.2

SSD 512GB 2280 PCIe NVMe Value	**Form Factor**	M.2 2280
	Capacity	512GB
	NAND Type	QLC/TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Weight	0.02 lb (10 g)
	Interface	PCIe NVMe
	Maximum Sequential Read	Up To 1700 MB/s
	Maximum Sequential Write	Up To 1500 MB/s
	Logical Blocks	1,000,215,215
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	ATA Security; TRIM; L1.2

Technical Specifications

SSD 256GB 2280 PCIe NVMe Value	**Form Factor**	M.2 2280
	Capacity	256 GB
	NAND Type	TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Weight	0.02 lb (10 g)
	Interface	PCIe NVMe
	Maximum Sequential Read	Up To 1700 MB/s
	Maximum Sequential Write	Up to 1300 MB/s
	Logical Blocks	500,118,192
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	ATA Security, TRIM; L1.2

512GB 2280 PCIe-3x2x2 NVMe+SSD 32GB 3D Xpoint	**Form Factor**	M.2 2280
	Capacity	512 GB
	NAND Type	QLC+3D Xpoint
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Weight	0.02 lb (10 g)
	Interface	PCIe NVMe Gen3X2X2
	Maximum Sequential Read	Up To 2400 MB/s
	Maximum Sequential Write	Up To 1300 MB/s
	Logical Blocks	1,000,215,215
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	ATA Security, TRIM; L1.2

Technical Specifications

NETWORKING/COMMUNICATIONS

Intel® Wi-Fi 61 AX20[1] and Bluetooth® 5.0 802.11ax (2x2) supporting gigabit data rate[5] (vPro®)	**Wireless LAN Standards**	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac IEEE 802.11ax IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11i IEEE 802.11k IEEE 802.11r IEEE 802.11v
	Interoperability	Features Wi-Fi 6 technology
	Frequency Band	802.11b/g/n/ax •2.402 – 2.482 GHz 802.11a/n/ac/ax •4.9 – 4.95 GHz (Japan) •5.15 – 5.25 GHz •5.25 – 5.35 GHz •5.47 – 5.725 GHz •5.825 – 5.850 GHz
	Data Rates	•802.11b: 1, 2, 5.5, 11 Mbps •802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz) •802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, ,80MHz & 160MHz) • 802.11ax: MCS0 ~ MCS11, (1SS and 2SS) (20MHz, 40MHz, ,80MHz & 160MHz)
	Modulation	Direct Sequence Spread Spectrum OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM , 1024QAM
	Security[3]	•IEEE compliant 64 / 128 bit WEP encryption for a/b/g mode only •AES-CCMP: 128 bit in hardware •802.1x authentication •WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. •WPA2 certification •IEEE 802.11i •WAPI
	Network Architecture	Ad-hoc (Peer to Peer)
	Models	Infrastructure (Access Point Required)
	Roaming	IEEE 802.11 compliant roaming between access points
	Output Power[2]	• 802.11b : +18.5dBm minimum

Technical Specifications

	• 802.11g : +17.5dBm minimum • 802.11a : +18.5dBm minimum • 802.11n HT20(2.4GHz) : +15.5dBm minimum • 802.11n HT40(2.4GHz) : +14.5dBm minimum • 802.11n HT20(5GHz) : +15.5dBm minimum • 802.11n HT40(5GHz) : +14.5dBm minimum • 802.11ac VHT80(5GHz) : +11.5dBm minimum • 802.11ac VHT160(5GHz) : +11.5dBm minimum • 802.11ax HT40(2.4GHz) : +10dBm minimum • 802.11ax VHT160(5GHz) : +10dBm minimum"
Power Consumption	•Transmit mode:2.0 W •Receive mode:1.6 W •Idle mode (PSP)180 mW (WLAN Associated) •Idle mode:50 mW (WLAN unassociated) •Connected Standby/Modern Standby: 10mW •Radio disabled: 8 mW
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode
Receiver Sensitivity[4]	•802.11b, 1Mbps : -93.5dBm maximum •802.11b, 11Mbps : -84dBm maximum • 802.11a/g, 6Mbps : -86dBm maximum • 802.11a/g, 54Mbps : -72dBm maximum • 802.11n, MCS07 : -67dBm maximum • 802.11n, MCS15 : -64dBm maximum • 802.11ac, MCS0 : -84dBm maximum • 802.11ac, MCS9 : -59dBm maximum •802.11ax, MCS11(HT40): -59dBm maximum •802.11ax, MCS11(VHT160): -58.5dBm maximum
Antenna type	High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications
Form Factor	PCI-Express M.2 MiniCard with CNVi Interface
Dimensions	1. Type 2230: 2.3 x 22.0 x 30.0 mm 2. Type 1216: 1.67 x 12.0 x 16.0 mm
Weight	1. Type 2230: 2.8g 2. Type 126: 1.3g
Operating Voltage	3.3v +/- 9%
Temperature	**Operating** 14° to 158° F (–10° to 70° C) **Non-operating** –40° to 176° F (–40° to 80° C)
Humidity	**Operating** 10% to 90% (non-condensing) **Non-operating** 5% to 95% (non-condensing)
Altitude	**Operating** 0 to 10,000 ft (3,048 m) **Non-operating** 0 to 50,000 ft (15,240 m)
LED Activity	LED Amber – Radio OFF; LED White – Radio ON

Technical Specifications

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1 Wireless Technology

Bluetooth Specification	4.0/4.1/4.2/5.0/5.1 Compliant
Frequency Band	2402 to 2480 MHz
Number of Available Channels	Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH)
Signaling Data Rate	Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps BLE: 1 Mbps data rate; throughput up to 0.2 Mbps Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 9.5 dBm for BR and EDR.
Power Consumption	Peak (Tx): 330 mW Peak (Rx): 230 mW Selective Suspend: 17 mW
Bluetooth Software Supported	Microsoft Windows Bluetooth Software
Power Management	Microsoft Windows ACPI, and USB Bus Support
Certifications	FCC (47 CFR) Part 15C, Section 15.247 & 15.249
Power Management Certifications	ETS 300 328, ETS 300 826 Low Voltage Directive IEC950 UL, CSA, and CE Mark
Bluetooth Profiles Supported	BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy LE Privacy 1.2 –Extended Scanner Filter Policies LE Data Packet Length Extension FAX Profile (FAX) Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP)
Security & Manageability	Intel® vPro™ support with appropriate Intel® chipset components

Technical Specifications

1. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 is backwards compatible with prior 802.11 specs. The specifications for Wi-Fi 6 (802.11ax) are draft and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ax devices. Only available in countries where 802.11ax is supported.
2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
3. Check latest software/driver release for updates on supported security features.
4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).
5. Wi-Fi 5 or 6 is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

Intel® Wi-Fi 6[1] AX201 and Bluetooth® 5.0 802.11ax (2x2), supporting gigabit data rate[5] (non-vPro®)	**Wireless LAN Standards**	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac IEEE 802.11ax IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11i IEEE 802.11k IEEE 802.11r IEEE 802.11v
	Interoperability	Features Wi-Fi 6 technology
	Frequency Band	802.11b/g/n/ax •2.402 – 2.482 GHz 802.11a/n/ac/ax •4.9 – 4.95 GHz (Japan) •5.15 – 5.25 GHz •5.25 – 5.35 GHz •5.47 – 5.725 GHz •5.825 – 5.850 GHz
	Data Rates	•802.11b: 1, 2, 5.5, 11 Mbps •802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz) •802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, ,80MHz & 160MHz) • 802.11ax: MCS0 ~ MCS11, (1SS and 2SS) (20MHz, 40MHz, ,80MHz & 160MHz)
	Modulation	Direct Sequence Spread Spectrum OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM , 1024QAM
	Security[3]	•IEEE compliant 64 / 128 bit WEP encryption for a/b/g mode only •AES-CCMP: 128 bit in hardware

Technical Specifications

	•802.1x authentication •WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. •WPA2 certification •IEEE 802.11i •WAPI
Network Architecture	Ad-hoc (Peer to Peer)
Models	Infrastructure (Access Point Required)
Roaming	IEEE 802.11 compliant roaming between access points
Output Power[2]	• 802.11b: +18.5dBm minimum • 802.11g: +17.5dBm minimum • 802.11a: +18.5dBm minimum • 802.11n HT20(2.4GHz): +15.5dBm minimum • 802.11n HT40(2.4GHz): +14.5dBm minimum • 802.11n HT20(5GHz): +15.5dBm minimum • 802.11n HT40(5GHz): +14.5dBm minimum • 802.11ac VHT80(5GHz): +11.5dBm minimum • 802.11ac VHT160(5GHz): +11.5dBm minimum • 802.11ax HT40(2.4GHz): +10dBm minimum • 802.11ax VHT160(5GHz): +10dBm minimum"
Power Consumption	•Transmit mode 2.0 W •Receive mode 1.6 W •Idle mode (PSP) 180 mW (WLAN Associated) •Idle mode 50 mW (WLAN unassociated) •Connected Standby 10mW •Radio disabled 8 mW
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode
Receiver Sensitivity[4]	•802.11b, 1Mbps : -93.5dBm maximum •802.11b, 11Mbps : -84dBm maximum • 802.11a/g, 6Mbps : -86dBm maximum • 802.11a/g, 54Mbps : -72dBm maximum • 802.11n, MCS07 : -67dBm maximum • 802.11n, MCS15 : -64dBm maximum • 802.11ac, MCS0 : -84dBm maximum • 802.11ac, MCS9 : -59dBm maximum •802.11ax, MCS11(HT40): -59dBm maximum •802.11ax, MCS11(VHT160): -58.5dBm maximum
Antenna type	High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications
Form Factor	PCI-Express M.2 MiniCard with CNVi Interface
Dimensions	1. Type 2230: 2.3 x 22.0 x 30.0 mm 2. Type 1216: 1.67 x 12.0 x 16.0 mm
Weight	1. Type 2230: 2.8g 2. Type 126: 1.3g

Technical Specifications

Operating Voltage	3.3v +/- 9%	
Temperature	**Operating**	14° to 158° F (–10° to 70° C)
	Non-operating	–40° to 176° F (–40° to 80° C)
Humidity	**Operating**	10% to 90% (non-condensing)
	Non-operating	5% to 95% (non-condensing)"
Altitude	**Operating**	0 to 10,000 ft (3,048 m)
	Non-operating	0 to 50,000 ft (15,240 m)"
LED Activity	LED Amber – Radio OFF; LED Off – Radio ON	

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1 Wireless Technology

Bluetooth Specification	4.0/4.1/4.2/5.0/5.1 Compliant
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Signaling Data Rate	Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps BLE: 1 Mbps data rate; throughput up to 0.2 Mbps Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 9.5 dBm for BR and EDR.
Power Consumption	Peak (Tx): 330 mW Peak (Rx): 230 mW Selective Suspend: 17 mW
Bluetooth Software Supported	Microsoft Windows Bluetooth Software
Power Management	Microsoft Windows ACPI, and USB Bus Support
Certifications	FCC (47 CFR) Part 15C, Section 15.247 & 15.249
Power Management Certifications	ETS 300 328, ETS 300 826 Low Voltage Directive IEC950 UL, CSA, and CE Mark
Bluetooth Profiles Supported	BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy LE Privacy 1.2 –Extended Scanner Filter Policies LE Data Packet Length Extension

Technical Specifications

FAX Profile (FAX)
Basic Imaging Profile (BIP)2
Headset Profile (HSP)
Hands Free Profile (HFP)
Advanced Audio Distribution Profile (A2DP)

1. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 is backwards compatible with prior 802.11 specs. The specifications for Wi-Fi 6 (802.11ax) are draft and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ax devices. Only available in countries where 802.11ax is supported.
2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
3. Check latest software/driver release for updates on supported security features.
4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).
5. Wi-Fi 5 or 6 is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

Technical Specifications

Qualcomm® Snapdragon™ X55 5G Modem (5G + LTE CAT 20) [1]	**Technology/Operating bands**	WCDMA/HSDPA/HSUPA/HSPA+ operating bands: Band 1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL) Band 2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL) Band 4: 1710 to 1755 MHz (UL), 2110 to 2155 MHz (DL) Band 5: 824 to 849 MHz (UL), 869 to 894 MHz (DL) Band 6: 830 to 840 MHz (UL), 875 to 885 MHz (DL) Band 8: 880 to 915 MHz (UL), 925 to 960 MHz (DL) Band 9: 1750 to 1785 MHz(UL), 1845to 1880 MHz (DL) Band 19: 830 to 845 MHz (UL), 875 to 890 MHz (DL) LTE FDD/TDD operating bands: Band 1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL) Band 2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL) Band 3: 1710 to 1785 MHz (UL), 1805 to 1880 MHz (DL) Band 4: 1710 to 1755 MHz (UL), 2110 to 2155 MHz (DL) Band 5: 824 to 849 MHz (UL), 869 to 894 MHz (DL) Band 7: 2500 to 2570 MHz (UL), 2620 to 2690 MHz (DL) Band 8: 880 to 915 MHz (UL), 925 to 960 MHz (DL) Band 12: 699 to 716 MHz (UL), 729 to 746 MHz (DL) Band 13: 777 to 787 MHz (UL), 746 to 756 MHz (DL) Band 14: 788 to 798 MHz (UL), 758 to 768 MHz (DL) Band 17: 704 to 716 MHz (UL), 734 to 746 MHz (DL) Band 18: 815 to 830 MHz (UL), 860 to 875 MHz (DL) Band 19: 830 to 845 MHz (UL), 875 to 890 MHz (DL) Band 20: 832 to 862 MHz (UL), 791 to 821 MHz (DL) Band 25: 1850 to 1915 MHz (UL), 1930 to 1995 MHz (DL) Band 26: 814 to 849 MHz (UL), 859 to 894 MHz (DL) Band 28: 703 to 748 MHz (UL), 758 to 803 MHz (DL) Band 29: 717 to 728 MHz (DL) Band 30: 2305 to 2315 MHz (UL) 2350 to 2360 MHz (DL) Band 32: 1452 to 1496 MHz (DL) Band 34: 2010 to 2025 MHz (UL/DL) Band 38: 2570 to 2620 MHz (UL/DL) Band 39: 1880 to 1920 MHz (UL/DL) Band 40: 2300 to 2400 MHz (UL/DL) Band 41: 2496 to 2690 MHz (UL/DL) Band 42: 3400 to 3600 MHZ (UL/DL) Band 46: 5150 to 5925 MHZ (DL) Band 48: 3550 to 3700 MHZ (UL/DL) Band 66: 1710 to 1800 MHz (UL), 2110 to 2200 MHz (DL) Band 71: 663 to 698 MHz (UL), 617 to 652 MHz (DL) 5GNR Sub 6GHZ n1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL) n2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL) n3: 1710 to 1785 MHz (UL), 1805 to 1880 MHz (DL) n5: 824 to 849 MHz (UL), 869 to 894 MHz (DL) n7: 2500 to 2570 MHz (UL), 2620 to 2690 MHz (DL) n8: 880 to 915 MHz (UL), 925 to 960 MHz (DL) n12: 699 to 716 MHz (UL), 729 to 746 MHz (DL) n20: 832 to 862 MHz (UL), 791 to 821 MHz (DL) n28: 703 to 748 MHz (UL), 758 to 803 MHz (DL) n41: 2496 to 2690 MHz (UL/DL) n66: 1710 to 1800 MHz (UL), 2110 to 2200 MHz (DL) n71: 663 to 698 MHz (UL), 617 to 652 MHz (DL) n77: 3300 to 4200 MHz (UL/DL) n78: 3300 to 3800 MHz (UL/DL) n79: 4400 to 5000 MHz (UL/DL)

Technical Specifications

Wireless protocol standards	5GNR Air Interface l 3GPP Rel15 5G NR sub-6 LTE Rel14 20 layers and 2 Gbps downlink (DL) throughput – 4 × 4 MIMO across 5x CA 200 Mbps uplink (UL) throughput – 40 MHz ULCA and 256 QAM WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification
GPS	Standalone, A-GPS (MS-A, MS-B)
GPS bands	GPS: L1 (1575.42MHz); L5 (1176MHz) GLONASS: L1 (1602MHz) BeidouB1(1561.098MHz) Galileo E1 (1575.42); E5a (1176MHz)
Maximum data rates	5G sub 6G : 3.8 Gbps LTE: ue-CategoryDL 20, (DL : 2 Gbps) ue-CategoryUL 13 , (UL: 150Mbps) DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21Mbps (Download), 5.76 Mbps (Upload)
Maximum output power	LTE: 23 dBm in all band except B41 LTE B41 HPUE = 26dBm HSPA+: 23.5 dBm
Maximum power consumption	5G Sub 6 : 2500 mA LTE: 1,300 mA (peak); 1100 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average)
Form Factor	M.2, 3042-S3 Key B
Weight	8 g
Dimensions (Length x Width x Thickness)	42 mm × 30 mm × 2.6 mm

1. 5G module is an optional feature that must be configured at purchase. AT&T and T-Mobile networks supported in the U.S. Module designed for 5G networks as carriers deploy Evolved-Universal Terrestrial Radio Access New Radio Dual Connectivity (ENDC) with both 100Mhz of 5G NR and LTE channel bandwidth, using 256QAM 4x4 as defined by 3GPP, requires activation and separately purchased service contract. Check with service provider for coverage and availability in your area. Connection, upload and download speeds will vary due to network, location, environment, network conditions, and other factors. 5G not available on all products, in all regions. Backwards compatible to 4G LTE and 3G HSPA technologies. 5G module planned to be available in select countries, where carrier supported.

Technical Specifications

Intel® XMM™ 7360 LTE-Advanced [1]	**Technology/Operating bands**	FDD LTE: LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3) , 1700 (Band 4), 850 (Band 5), 2600 (Band 7), 900 (Band 8) , 1400 (Band 11), 700 (Band 12), 700 (Band 13) 700 (Band 17) , 850 (Band 18) , 850 (Band 19), 800 (Band 20), 1450 (Band 21) , 850 (Band 26) 700 (Band 28) MHz, 700 (Band 29) , 2300 (Band 30) , 2100 (Band 66) MHz TDD LTE: 2600 (Band 38) , 1900 (Band 39) , 2300 (Band 40) , 2500 (Band 41) MHz HSPA+: 2100 (Band 1), 1900 (Band 2), 1700 (Band 4), 850 (Band 5), 900 (Band 8) MHz
	Wireless protocol standards	3GPP Release 11 LTE Specification CAT.9, MAX 60MHz aggregation BW WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification
	GPS	Standalone, A-GPS (MS-B and LTO)
	GPS bands	GPS 1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz, Beidou 1561.098 ± 2.046 MHz
	Maximum data rates	LTE: 450 Mbps (DL 3CA), 50 Mbps (Upload) DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21Mbps (Download), 5.76 Mbps (Upload)
	Maximum output power	LTE: 23 dBm HSPA+: 23.5 dBm
	Maximum power consumption	LTE: 1,200 mA (peak); 900 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average)
	Form Factor	M.2, 3042-S3 Key B
	Weight	6 g
	Dimensions (Length x Width x Thickness)	42 x 30 x 2.3 mm

1. WWAN module is an optional feature, requires factory configuration and requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. LTE not available on all products, in all regions.

Technical Specifications

POWER

AC Adapter 65 Watt nPFC Slim USB type C Straight 1.0m	**Dimensions**	88x53.5x21mm	
	Weight	unit: 220g +/- 10g	
	Input	100 to 240 VAC	
		Input Efficiency	81.5% min at 115 Vac/ 230Vac @ 5V/3A 86.7% min at 115 Vac/ 230Vac @ 9V/3A 88% min at 115 Vac/ 230Vac @ 12V/5A 89% min at 115 Vac/ 230Vac @ 15V/4.33A 89% min at 115 Vac/ 230Vac @ 20V/3.25A
		Input frequency range	47 ~ 63 Hz
		Input AC current	1.6 A at 90 VAC and maximum load
	Output	**Output power**	65W
		DC output	5V/9V/12V/15V/20V
		Hold-up time	5ms at 115 Vac input
		Output current limit	<8.0A
	Connector	USB Type-C	
	Environmental Design	**Operating temperature**	32°Fto 95°F (0°to 35°C)
		Non-operating (storage) temperature	-4°Fto 185°F (-20°to 85°C)
		Altitude	0 to 16,400 ft (0 to 5000m)
		Humidity	5% to 95%
		Storage Humidity	5% to 95%
	EMI and Safety Certifications	Eg: *CE Mark - full compliance with LVD and EMC directives * Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. * MTBF - over 100,000 hours at 25°C ambient condition.	

AC Adapter 65 Watt nPFC Standard USB type C Straight 1.0m	**Dimensions**	90.0x51x28.5mm	
	Weight	unit: 250g +/- 10g	
	Input	100 to 240 VAC	
		Input Efficiency	81.5% min at 115 Vac/ 230Vac @ 5V/3A 86.7% min at 115 Vac/ 230Vac @ 9V/3A 88% min at 115 Vac/ 230Vac @ 12V/5A 89% min at 115 Vac/ 230Vac @ 15V/4.33A 89% min at 115 Vac/ 230Vac @ 20V/3.25A
		Input frequency range	47 ~ 63 Hz
		Input AC current	1.6 A at 90 VAC and maximum load
	Output	**Output power**	65 W
		DC output	5V/9V/12V/15V/20V
		Hold-up time	5ms at 115 Vac input
		Output current limit	8.0A Max.

Technical Specifications

	Connector	USB TYPE C	
	Environmental Design	**Operating temperature**	32°F to 95°F (0°to 35°C)
		Non-operating (storage) temperature	-4°F to 185°F (-20°to 85°C)
		Altitude	0 to 16,400 ft (0 to 5000m)
		Humidity	20% to 95%
		Storage Humidity	10% to 95%
	Safety Certifications	- CE Mark - full compliance with LVD and EMC directives - Worldwide safety standards -IEC60950, EN60950, UL60950, UL62368, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. - MTBF - over 200,000 hours at 25°C ambient condition.	

HP 4-cell Long Life Li-Ion(56Wh)	**Dimensions** (H x W x L)	5.25x85.00x274.00 mm	
	Weight	0.259 kg	
	Cells/Type	4cell Lithium-Ion Polymer cell / 446872	
	Energy	**Voltage**	8.8V/7.7V
		Amp-hour capacity	7.3Ah/7.0Ah
		Watt-hour capacity	56 Wh
	Temperature	**Operating (Charging)**	32˚ to 113˚ F (0˚ to 45˚ C)
		Operating (Discharging)	14˚ to 122˚ F (-10˚ to 60˚ C)
	Optional Travel Battery Available	No	

HP 2-cell Long Life Li-Ion(38Wh)	**Dimensions** (H x W x L)	5.20*79.40*274.00	
	Weight	0.16 kg	
	Cells/Type	2cell Lithium-Ion Polymer cell / 4453C2	
	Energy	**Voltage**	8.8V/7.7V
		Amp-hour capacity	4.93Ah/4.68Ah
		Watt-hour capacity	38 Wh
	Temperature	**Operating (Charging)**	32˚ to 113˚ F (0˚ to 45˚ C)
		Operating (Discharging)	14˚ to 122˚ F (-10˚ to 60˚ C)
	Optional Travel Battery Available	No	

COUNTRY OF ORIGIN

China

Options and Accessories (sold separately and availability may vary by country)

Type	Description	Part #
Cases	HP Business Slim 14.1 Top Load	2SC65AA,2SC65UT,2SC65ET
	HP Executive 15.6 Backpack	6KD07AA,6KD07UT,6KD07ET
	HP Executive Slim 14.1 Top Load	6KD04AA,6KD04UT,6KD04ET
Docking	HP Thunderbolt 120W Dock G2	6HP48AA,2UK37AA,2UK37ET
	HP Thunderbolt 120W Dock w/Audio G2	3YE87AA,2UK37UT,3YE87ET
	HP Thunderbolt 230W Dock w/Combo Cable G2	3TR87AA,3TR87UT,3TR87ET
	HP USB-C 120W G5 Dock	26D32AA,5TW10AA,5TW10UT,5TW10ET
	HP USB-C Mini Dock	2SR85AA,1PM64AA,1PM64UT,1PM64ET
	HP USB-C/A 120W Universal Dock G2	5TW13AA,5TW13UT,5TW13ET
Input/Output	HP HDMI to VGA Adapter	H4F02AA, H4F02UT, H4F02ET
	HP TB Dock 120W G2 Cable	3XB94AA, 3XB94UT, 3XB94ET
	HP TB Dock 230W G2 Combo Cable	3XB96AA, 3XB96UT, 3XB96ET
	HP USB to Gigabit RJ45 Adapter	N7P47AA, N7P47UT
	HP USB-C to DisplayPort Adapter	N9K78AA, N9K78UT
	HP USB-C to RJ45 Adapter	V8Y76AA, V7W66AA, V7W66UT
	HP USB-C to USB-A Hub	Z8W90AA, Z6A00AA, Z6A00UT, Z6A00ET
	HP USB-C to VGA Adapter	P7Z54AA, N9K76AA, N9K76UT
	HP Wireless USB Premium Keyboard	Z9N41AA, Z9N41AT
	HP WL USB Keyboard	T6U20AA, T6U20UT
	HP Slim Wireless Keyboard and Mouse	T6L04AA, T6L04UT
	HP Wired Desktop 320MK Mouse and Keyboard	9SR36AA, 9SR36UT, 9SR36ET
	HP Wireless Rechargeable 950MK Mouse and Keyboard	3M165AA
	HP 320M Wired Mouse	9VA80AA, 9VA80UT, 9VA80ET
	HP Comfort Grip Wireless USB Mouse	H2L63AA, H2L63UT
	HP Premium USB Mouse	1JR32AA, 1JR32UT
	HP Premium Wireless Mouse	1JR31AA, 1JR31UT
	HP Presenter Bluetooth Mouse	2CE30AA, 2CE30UT, 2CE30ET
	HP Travel Bluetooth Mouse	6SP30AA, 6SP30UT, 6SP30ET
	HP Travel USB Mouse	G1K28AA, G1K28ET
	HP Ultra Mobile Wireless Mouse	H6F25AA, H6F25UT
	HP X4000 Bluetooth Wireless 2.4 GHz Mouse	H3T50AA, H3T50UT
	HP Rechargeable Active Pen G3	6SG43AA
Power	HP 65W USB-C AC Power Adapter	1HE08AA, 1HE08UT
	HP 65W USB-C LC AC Power Adapter	1P3K6AA, 1P3K6UT
	HP 65W USB-C Slim Travel AC Power Adapter	X7W50AA, 3PN48AA, 3PN48UT
	HP USB Power Bank	N9F71AA, N9F71UT
	HP USB-C Essential Power Bank	3TB55AA, 3TB55UT

Options and Accessories (sold separately and availability may vary by country)

Storage

HP USB DVD-Writer EXT ODD	Y3T76AA, F2B56AA, F2B56UT, F2B56ET

Security

HP Nano Cable Lock	1AJ39AA, 1AJ39UT
HP SureKey Standard/Nano/Wedge Cable Lock	6UW42AA, 6UW42UT

UCC

HP BT UC WL Duo Headset	W3K09AA#ABB, W3K09AA#UUF
HP Wired Thunderbolt Audio Module	3AQ21AA, 3AQ21UT, 3AQ21ET
HP Wired USB-A Stereo Headset	T1A67AA
HP Wireless BT UC WL Mono Headset	W3K08AA#ABB, W3K08AA#UUF

Summary of Changes

Date of change:	Version History:		Description of change:
January 22nd 2021	V1 to V2		At a Glance section update